



COMPLIMENTARY PAIR ENHANCEMENT MODE MOSFETS

This space-efficient device contains an electrically-isolated complimentary pair of enhancement-mode MOSFETs (one N-channel and one P-channel). It comes in a very small SOT-363 (SC70-6L) package. This device is ideal for portable applications where board space is at a premium.

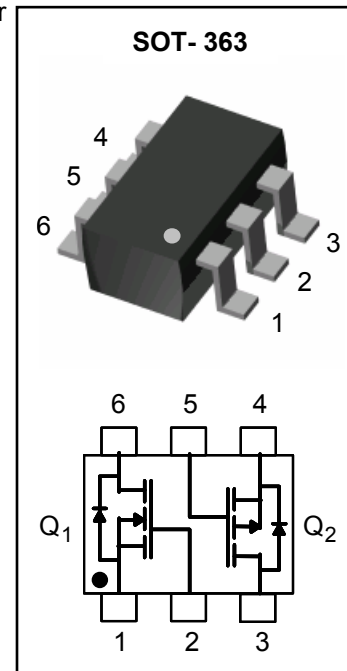
FEATURES

- Complimentary Pairs
- Low On-Resistance
- Low Gate Threshold Voltage
- Fast Switching
- Available in lead-free plating (100% matte tin finish)

APPLICATIONS

- Switching Power Supplies
- Hand-Held Computers, PDAs

MARKING CODE: S82



MAXIMUM RATINGS - TOTAL DEVICE $T_J = 25^{\circ}\text{C}$ Unless otherwise noted

Rating	Symbol	Value	Units
Total Power Dissipation (Note 1)	P_D	200	mW
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +150	$^{\circ}\text{C}$

MAXIMUM RATINGS N - CHANNEL - Q_1 , 2N7002 $T_J = 25^{\circ}\text{C}$ Unless otherwise noted

Rating	Symbol	Value	Units
Drain-Source Voltage	V_{DSS}	60	V
Drain-Gate Voltage $R_{GS} < 1.0\text{Mohm}$	V_{DGR}	60	V
Gate-Source Voltage - Continuous	V_{GSS}	± 20	V
Drain Current - Continuous (Note 1)	I_D	115	mA

MAXIMUM RATINGS P - CHANNEL - Q_2 , BSS84 $T_J = 25^{\circ}\text{C}$ Unless otherwise noted

Rating	Symbol	Value	Units
Drain-Source Voltage	V_{DSS}	-50	V
Drain-Gate Voltage $R_{GS} < 20\text{Kohm}$	V_{DGR}	-50	V
Gate-Source Voltage - Continuous	V_{GSS}	± 20	V
Drain Current - Continuous (Note 1)	I_D	130	mA

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Units
Thermal Resistance, Junction to Ambient (Note 1)	R_{thja}	625	$^{\circ}\text{C/W}$

Note 1. FR-5 board 1.0 x 0.75 x 0.062 inch with minimum recommended pad layout



Electrical Characteristics - N-CHANNEL - Q₁, 2N7002 $T_J = 25^\circ\text{C}$ Unless otherwise noted

OFF CHARACTERISTICS (Note 2)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 10\mu\text{A}$, $V_{GS} = 0\text{V}$	60	80	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60\text{V}$, $V_{GS} = 0$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	-	-	1.0 500	μA
Gate-Body Leakage	I_{GSS}	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$	-	-	± 10	nA

ON CHARACTERISTICS (Note 2)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	1.0	1.6	2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 5\text{V}$, $I_D = 0.05\text{A}$ $V_{GS} = 10\text{V}$, $I_D = 0.5\text{A}$	-	1.8 2.0	4.5 7.0	Ohms
On-State Drain Current	$I_{D(ON)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 7.5\text{V}$	0.5	1.65	-	A
Forward Transconductance	g_{FS}	$V_{DS} = 10\text{V}$, $I_D = 0.2\text{A}$	0.08	-	-	S

DYNAMIC CHARACTERISTICS

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input Capacitance	C_{iss}	$V_{DS} = 25\text{V}$, $V_{GS} = 0\text{V}$, $f = 1.0\text{MHz}$	-	-	50	pF
Output Capacitance	C_{oss}		-	-	25	pF
Reverse Transfer Capacitance	C_{rss}		-	-	5.0	pF

SWITCHING CHARACTERISTICS

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD} = 30\text{V}$, $I_D = 0.2\text{A}$, $R_L = 150\text{ohm}$ $R_{GEN} = 25\text{ohm}$, $V_{GEN} = 10\text{V}$	-	-	20	ns
Turn-Off Delay Time	$t_{D(OFF)}$		-	-	20	ns

Note 2. Short duration test pulse used to minimize self-heating



Electrical Characteristics - P-CHANNEL - Q₂ , BSS84 T_J = 25°C Unless otherwise noted

OFF CHARACTERISTICS (Note 3)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = -250μA, V _{GS} = 0V	-50	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -50V, V _{GS} = 0V, T _J = 25°C	-	-	-15	μA
		V _{DS} = -50V, V _{GS} = 0V, T _J = 125°C	-	-	-60	
		V _{DS} = -25V, V _{GS} = 0V, T _J = 25°C	-	-	-0.1	
Gate-Body Leakage	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	±10	nA

ON CHARACTERISTICS (Note 3)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -1mA	-0.8	1.44	-2.0	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} = -5V, I _D = -0.1A	-	3.8	10	Ohms
Forward Transconductance	g _{FS}	V _{DS} = -25V, I _D = -0.1A	0.05	-	-	S

DYNAMIC CHARACTERISTICS

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input Capacitance	C _{iss}	V _{DS} = -25V, V _{GS} = 0V, f = 1.0MHz	-	-	45	pF
Output Capacitance	C _{oss}		-	-	25	pF
Reverse Transfer Capacitance	C _{rss}		-	-	12	pF

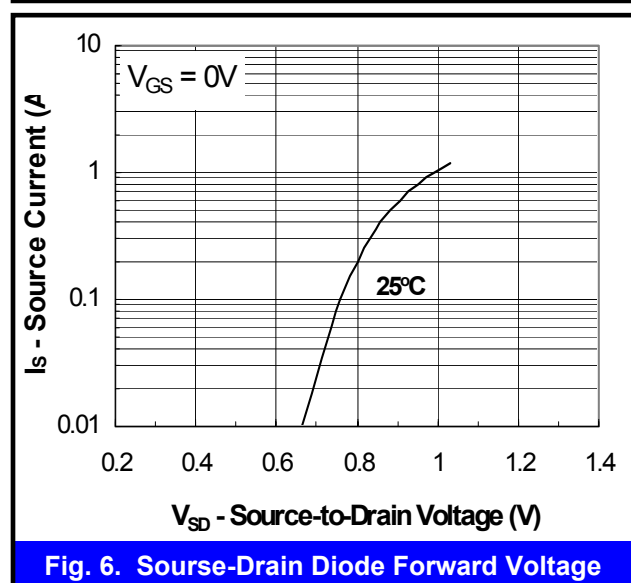
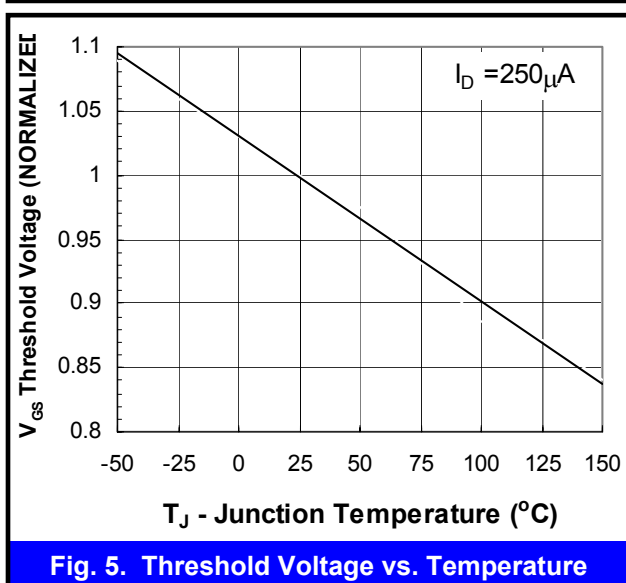
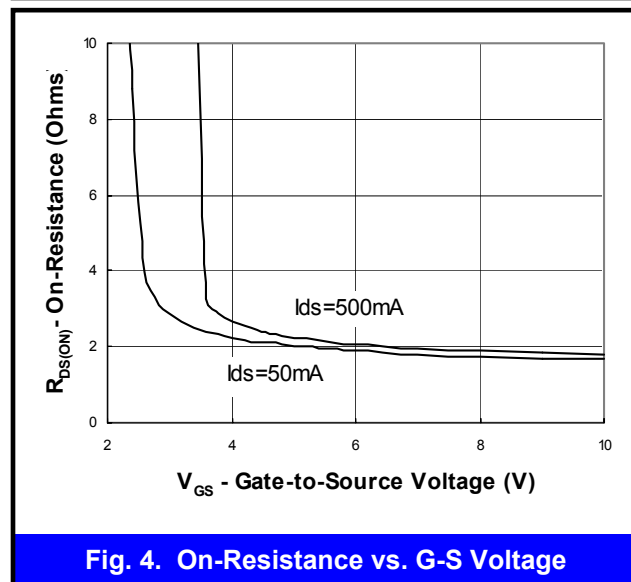
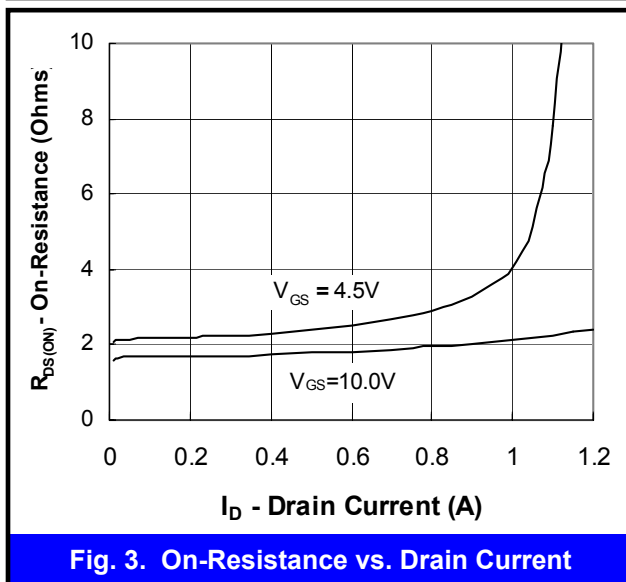
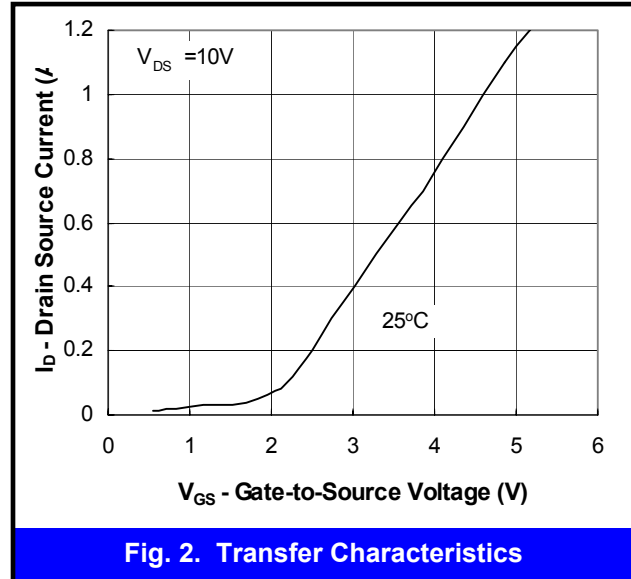
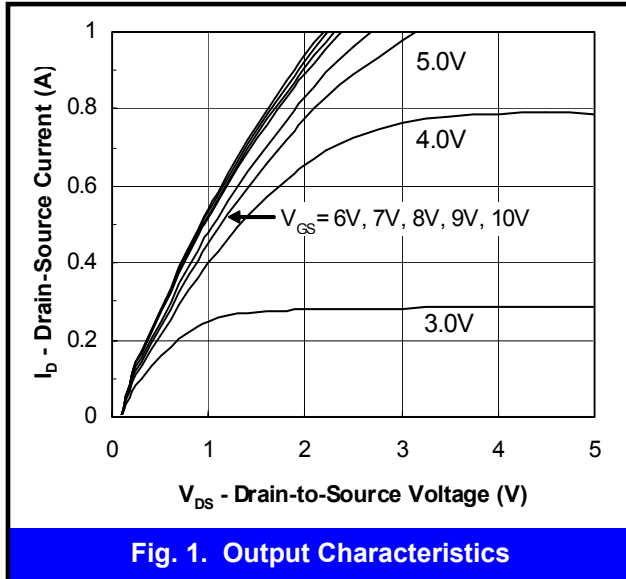
SWITCHING CHARACTERISTICS

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Turn-On Delay Time	t _{D(ON)}	V _{DD} = -30V, I _D = -0.27A, R _{GEN} = 50ohm, V _{GS} = -10V	-	7.5	-	ns
Turn-Off Delay Time	t _{D(OFF)}		-	25	-	ns

Note 3. Short duration test pulse used to minimize self-heating

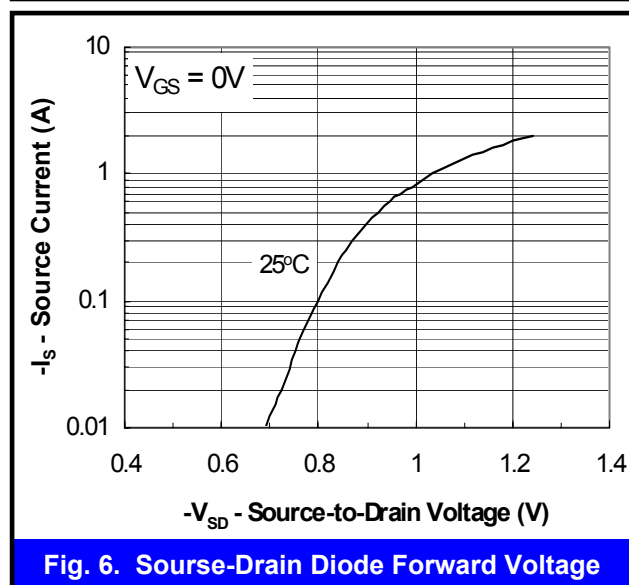
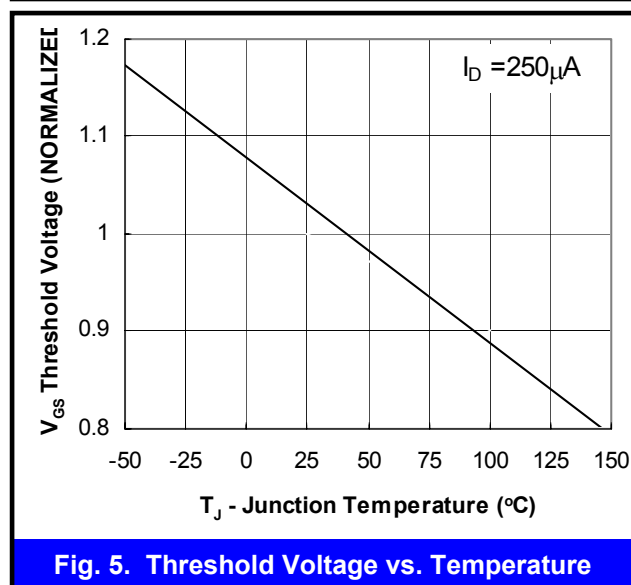
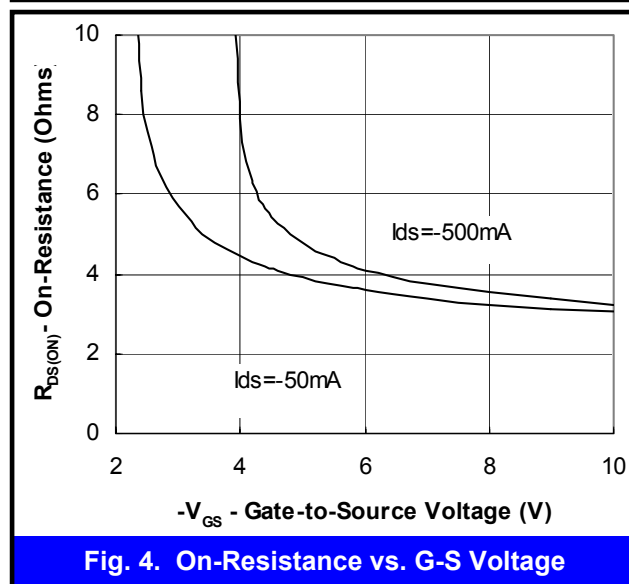
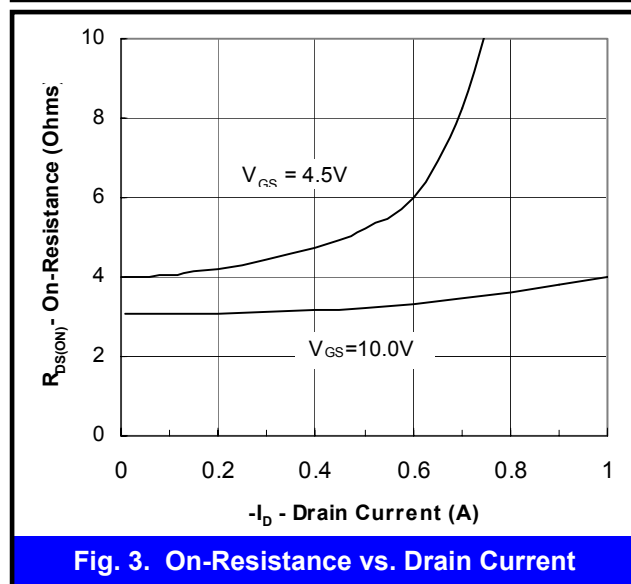
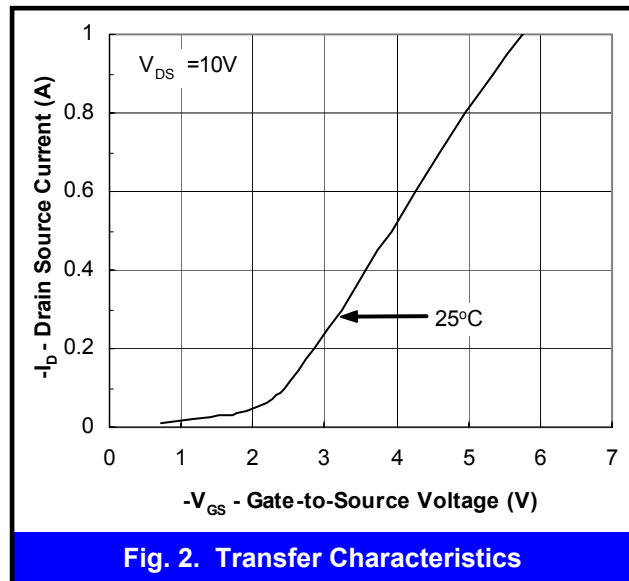
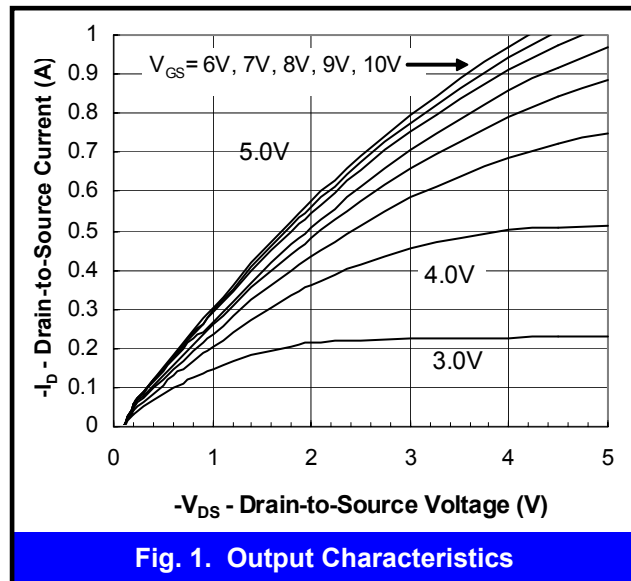


Typical Characteristics Curves - N-Channel - Q₁, 2N7002 $T_J = 25^\circ\text{C}$ Unless otherwise noted



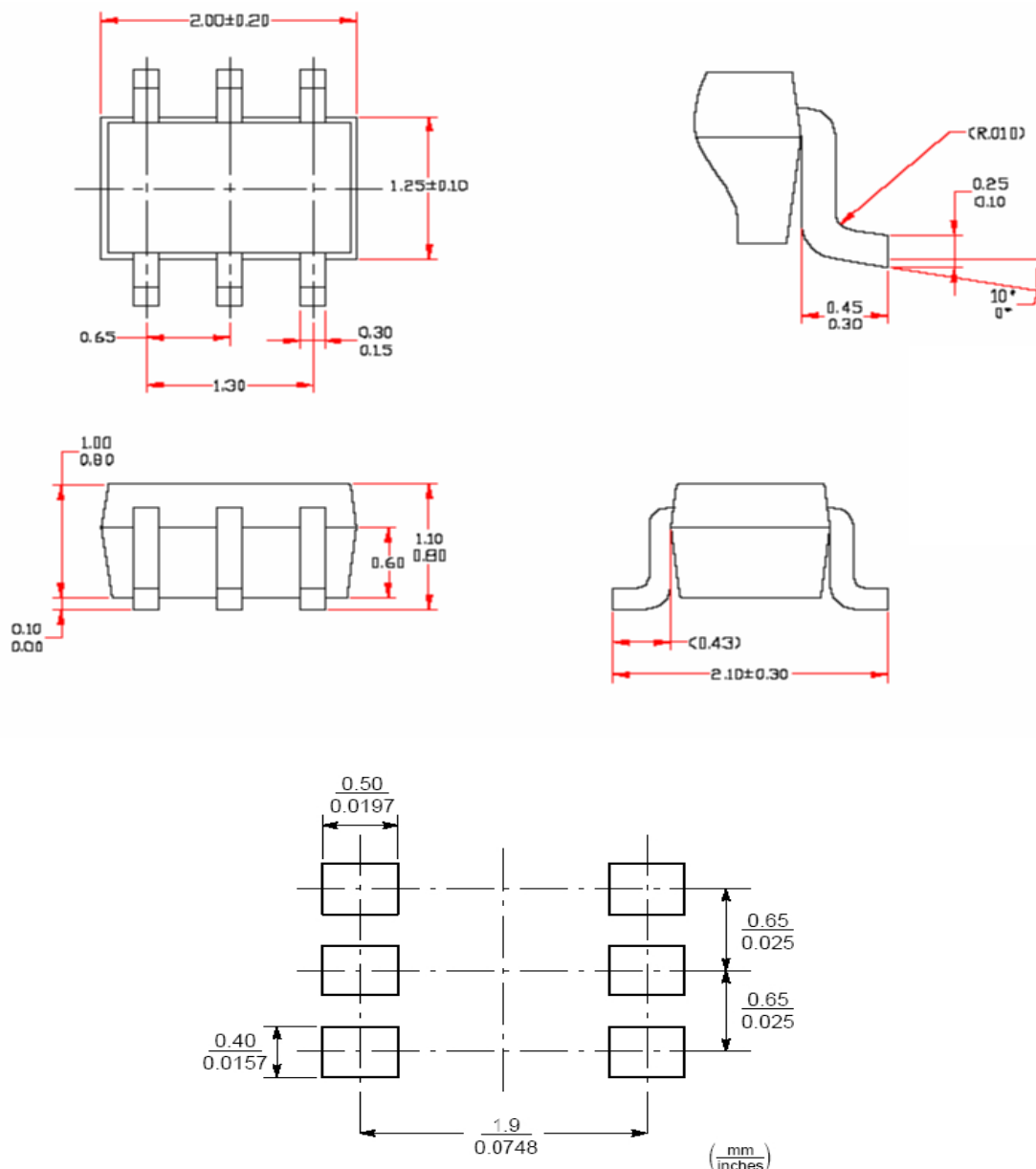


Electrical Characteristic Curves - P-Channel - Q_2 , BSS84 $T_J = 25^\circ\text{C}$ Unless otherwise noted





PACKAGE LAYOUT AND SUGGESTED PAD DIMENSIONS



ORDERING INFORMATION

BSS8402DW T/R7: 7 inch reel, 3K units per reel, Pin 1 towards tape sprocket holes

BSS8402DW T/R7-R: 7 inch reel, 3K units per reel, Pin 1 away from tape sprocket holes

BSS8402DW T/R13: 13 inch reel, 10K units per reel, Pin 1 towards tape sprocket holes

BSS8402DW T/R13-R: 13 inch reel, 10K units per reel, Pin 1 away from tape sprocket holes

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